**MicroShield™** forms a robust, abrasion resistant surface that stands up to repeated cleaning

MicroShield is a revolutionary on-contact hydrophobic, oleophobic and permanent coating technology that can be applied to solder paste stencils to impart a unique range of properties, including: better paste release, improved paste deposit profile, significantly reduced cleaning frequency and reduced bridging. MicroShield is easy to apply and instantly improves stencil printing.

**Reduced Bridging**

**Reduction in Underside Cleaning**

**Better Paste Release from Aperture**

**Improved Solder Paste Brick Profiles**

For more information on how MicroShield can improve your printing process, please visit our website!

[www.nanoslic.com](http://www.nanoslic.com)